Panasonic

Ultra High-speed / High-precision

Laser Displacement Sensor

HL-C2_{SERIES}











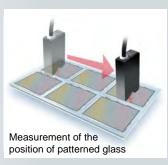
Panasonic Laser Displacement Sensors are the No. 1* industry leader in application compatibility with 34 different sensor head variations

*As of May 2017, in-company survey

Examples of Applied Use



Semiconductor and liquid crystal industries



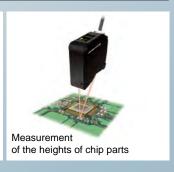




Electrical and electronics-related industries







MSGB HDLC-CMOS sensor High-resolution lens

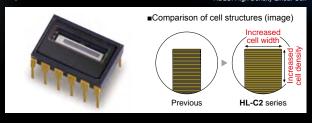
Combining our accumulated and the latest technologies to accomplished* functionality

Our proprietary measurement CMOS, the "HDLC-CMOS Sensor"

The HDLC-CMOS sensors have been developed specially for the HL-C2 series.

High density light-receiving cells and a processing speed close to the maximum limit result in high resolutions and high speeds which exceed all expectations for laser displacement sensors.

HDLC: High Density Linear Cell



A diverse track record proving our products' capabilities and reliability

Since its debut, the HL-C2 series has come to be used for our customers' measurement applications in a wide variety of industries. We provide the most capable laser displacement sensors with high-speed, high-accuracy functionality to meet our customers' requests for measurement applications.

Automotive-related industries

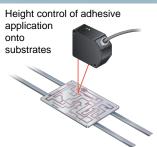






Metal / plastic / rubber industries







measurement expertise create the most in the industry *As of May 2017, in-company survey

"MSGB" laser with sharp and fine projection

We have created the ideal laser using our proprietary optical technologies and aperture construction. Furthermore emission adjustment algorithms have been redesigned to maintain ideal emission conditions

MSGB: Micro Spot Gaussian Beam ■Comparison of beam diameter HL-C2

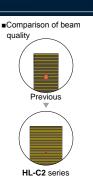
"Ultra high-speed calculation processor"

Using our specialized proprietary IC and custom algorithms for high-speed processing, information is digitally transmitted between the sensor head and controller. Both high-speed transmission and stability are realized for measurement values.



"High-resolution lens" for realizing stable optical path lengths

We designed a new high-resolution lens to reduce lens aberration as much as possible. Light entering from any angle can be gathered at a minimum point to realize even higher precision



A Full Product Lineup for Meeting the Application Needs of Customers





Separated emitter and receiver for

stable measurement

■HL-C201A-SP2(M), HL-C201A-SP3(M)

The laser emitter and receiver are separated so that the detection point can be positioned at the center axis of the camera lens.



The nozzle's drop-down point and displacement sensor's measurement point could not be placed on the same axis.

Separated construction for light emission and reception



By alingning the drop-down point and measurement point along the same axis, more stable measurements becomes possible.

A choice of sensor heads to match your application

2 formats and 2 types provide a choice of



Measurement center distance: 8 mm 0.315 in

- Small beam spot type HL-C201A-SP2
- Linear beam spot type HL-C201A-SP2M



Measurement center distance: 15 mm 0.591 in

- Small beam spot type HL-C201A-SP3
- Linear beam spot type HL-C201A-SP3M

We brought together our accumulated measurement expertise with the latest technologies to create the world-class HL-C2 series. These sensors will meet your various short-range and long-range needs.





diffuse and specular reflection

■HL-C203B(-MK), HL-C205□(-MK), HL-C208□(-MK), HL-C211 (-MK), HL-C235 (-MK), HL-C235 (E-W(MK)





HL-C235BE(-MK) HL-C235CE(-MK) Measurement center distance 13.780 in Measuring range $\pm 50 \, \mathrm{mm}$ +1.969 in Resolution 0.5 µm

HL-C235CE-W(MK) Measurement center distance $350 \, \mathrm{mm}$ Measuring range $\pm 200~\mathrm{mm}$ Resolution $\begin{array}{c} 2~\mu m \\ 0.079~\mathrm{mil} \end{array}$

A Diverse Array of Sensor Heads for Your Application Needs

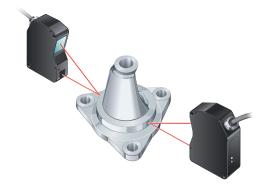
For automobile and vehicle parts measurement

Automobile and vehicle parts production facilities



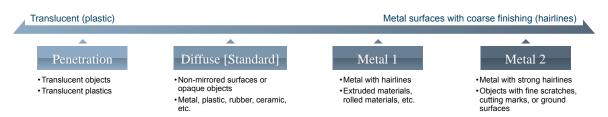






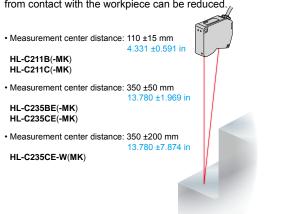
The measurement mode setting is compatible with a variety of workpieces

Select the optimal digital processing for the object to be measured.



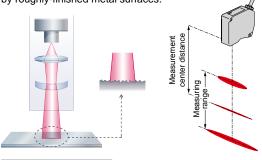
Long-range sensor heads

Our lineup includes long-range sensor heads with measurement center distances of 110 mm 4.331 in and 350 mm 13.780 in. By keeping distance from the workpiece, the risk of sensor damage from contact with the workpiece can be reduced.



Linear beam spot type sensor heads

We offer linear beam spot type sensor heads with various measurement center distances that are not easily distorted by roughly-finished metal surfaces.



Small beam spot type optical waveform
Linear beam spot type optical waveform

Even surfaces that appear to be flat have minor surface variations when viewed under magnification. These variations can cause errors in measurement. Linear beam spot type sensors average out the influence of these variations, allowing for stable measurement of roughly-finished workpieces.

The diverse capabilities of the HL-C2 series can be used for stable measurement with higher precision for a variety of materials.



For measurement of glass height and thickness [FPD and solar panel production facilities









The measurement mode setting is compatible with a variety of workpieces

A specular reflection installation is required for measurement of transparent and mirrored-surface objects. Select the digital processing for the measurement application.



Glass Gaps between glass, glass thickness



- objects

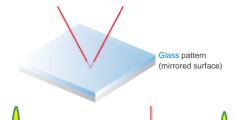
When emission

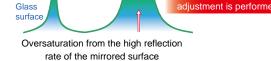
- · Glass front and back surfaces

Patterned glass

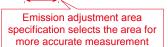
Emission adjustment area specification allows for measurement of glass surfaces

Glass surfaces can be accurately measured by combining the "Emission Adjustment" that determines the optimal emission amounts with the "Emission Adjustment Area Specification" that identifies the specific area to measure the emission.





Reducing emission to avoid oversaturation results in a reduction of the originally-targeted waveform

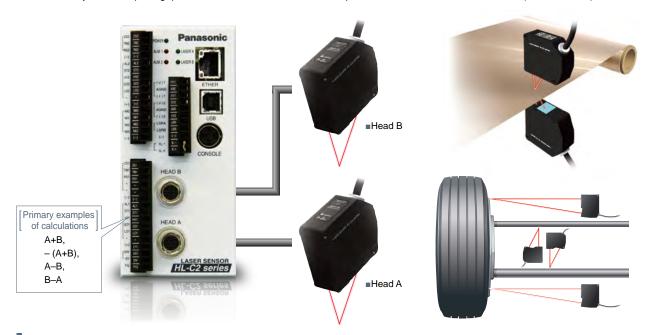




Controllers that Provide Both Convenience and Improved Product Quality

On-board processing for calculations of 2 sensor heads

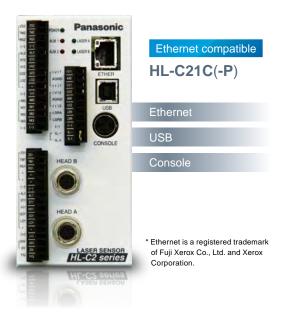
The controller is equipped to perform basic calculations and output results for applications such as thickness measurement for sandwiched layers and 2-point gap measurement. This can reduce computational burdens for host controllers (such as PLCs).



Connectivity to host controllers

Our controller lineup offers Ethernet, USB, and RS-232C connections. The controllers can connect to devices such as PCs and PLCs.

*An API (Application Programming Interface) and sample programs can be downloaded for free from our web site for operating the controller using a PC connected by USB.



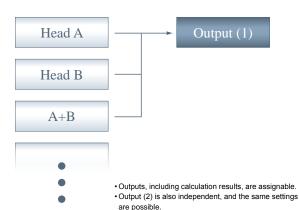


Since two sensor heads can be connected for simultaneous use, and since basic calculations optimized for applications such as thickness measurement or difference measurement are integrated in the controller, independent control is possible. Accumulating the measurement values without sacrificing high-speed sampling contributes to the high quality of the product.



A full range of output ports allows output in line with your needs

Both Output (1) and Output (2) mounted on the controller provide independent analog outputs, various output signals (judgment, alarm, etc.), and various input signals (laser emission stop, zero set, etc.).



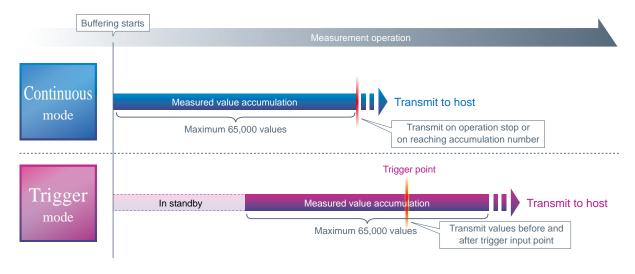
	o: Available	Output (1)	Output (2)
	Analog voltage	0	0
Output circuit	Analog current	0	0
out ci	Hi / Go / Low judgment	0	0
Outp	Alarm	0	0
	Strobe	0	0
cuit	Zero set	0	0
Input circuit	Timing	0	0
Inpu	Reset	0	0

^{*}Other functions such as laser control (emission stop) input and memory change are also on-board.

Buffering function allows for temporary accumulation of measured values

The buffering function allows measurement values acquired from high-speed sampling (10 µs) to temporarily accumulate in the controller, which are then transmitted to the host. A maximum of 65,000 values can be accumulated. The accumulation of shape data can contribute to traceability and other activities.

Furthermore, in trigger mode, by sending a trigger input when there is an error, measured values before and after the error can be acquired to help determine the cause of the error.

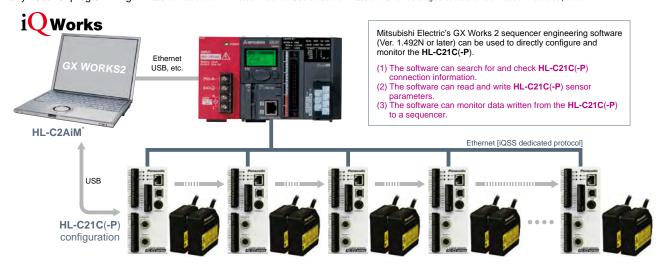




Providing Increased Connectivity and Compatibility with Host Devices

Measurement status can be acquired with a programmable controller easily and without any need for programming!

The **HL-C21C(-P)** supports the MEWTOCOL protocol (used by our programmable controllers), the MC protocol (used by Mitsubishi Electric's MELSEC-Q and MELSEC-L series) as well as the iQSS dedicated protocol (used by Mitsubishi Electric's MELSEC-L series), allowing measured values and other information to be written automatically to the data registers of programmable controllers without any need for programming. *iQSS is an abbreviation for Mitsubishi Electric's iQ Sensor Solution. *iQSS and iQ Works are registered trademarks of Mitsubishi Electric Corporation.

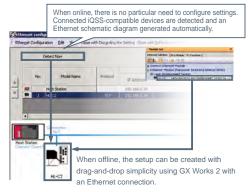


*HL-C2AiM: HL-C2 dedicated intelligent monitor (available for download free of charge on our website)

Easy setup

HL-C21C(-P) connection settings can be set up using automatic detection of connected devices and drag-and-drop simplicity.

→ Reduces development man-hours.



*Use Mitsubishi Electric's GX Works 2 sequencer engineering software (Ver. 1.492N or later).

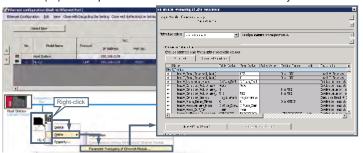
Sensor monitoring

The **HL-C21C(-P)**'s measurement status can be easily monitored.



Reading and writing of sensor parameters

HL-C21C(-P) sensor parameters can be read and written easily.



- *The HL-C21C(-P)'s Ethernet communications settings must be configured using Configurator WD (Ver.
- 1.62 or later of our Ethernet communications configuration tool). (This software is available for download free of charge from our website.)
- *The MC protocol is supported for the MELSEC-Q series, and sensors can be monitored.

We offer a full range of communication interfaces for connecting to various networks along with user interfaces that allow for easy setting of high-precision operation. This allows for program-less connectivity with our own programmable controllers as well as with Mitsubishi Electric Corp. sequencers.

Interfaces for convenient setup and setting changes

By combining the GT12 programmable display with our software tools accessed from a PC (HL-C2AiM Intelligent Monitor), received light intensity waveforms and other information can be displayed in addition to the display of measured-value data.

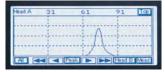
GT12 Programmable Display

Simple touch panel operation and easy-to-read display



By installing screen application (provided free of charge) onto the GT12 programmable display, it can be used as a dedicated console for viewing waveforms and setting operation conditions. (A proprietary connection cable is required.)

· Received light intensity in waveform display



Condition setting function



· Measurement value data display function







Intelligent Monitor

HL-C2AiM

Waveform monitoring and function setting by computer is easy to do

*This software is available for download free of charge from our website

OS (Note 1)	: Microsoft® Windows® 7 Professional 32 bit / 64 bit Microsoft® Windows® 8 Pro 32 bit / 64 bit Microsoft® Windows® 10 Pro 32 bit / 64 bit (Japanese / English / Korean / Chinese)
CPU	: Pentium compatible CPU 1 GHz or above (Note 2)
Memory	: 2 GB or more (Note)
Hard disk	: 50 MB or more of usable space
Display screen	: SXGA (1280 x 1024 full color) or above
Serial port	: RS-232C compliant, transmission speed 115.2 kbps
USB port	: USB 2.0 full speed (USB 1.1 compatible)

Notes: 1) Windows 7 / 8 / 10 are trademarks or registered trademarks of Microsoft Corporation in the United State and other countries.

2) Depends on the OS operation environment.





Light receiving intensity



ORDER GUIDE

Sensor heads

Type	Appearance	Measurement center distance and	Resolution	Beam size	Model N	o. (Note)	
.,,,,		measuring range	(Note 1)	203.71 0120	IEC/JIS conformed type	FDA conformed type	
Small beam spot type		10 ±1 mm	0.01 µm 0.0004 mil	ø20 μm ø0.787 mil approx.	HL-C201A * (HL-C201AE *)	HL-C201F (HL-C201FE)	
Linear beam spot type	CARRY HANGES PLCZ zarów	0.394 ±0.039 in	(0.25 μm 0.01 mil)	20 × 700 μm 27.559 mil approx.	HL-C201A-MK * (HL-C201AE-MK *)	HL-C201F-MK (HL-C201FE-MK)	
Small beam spot type	Å	8 ±0.8 mm	0.01 µm 0.0004 mil	ø20 μm ø0.787 mil approx.	HL-C201A-SP2 (HL-C201AE-SP2)		
Linear beam spot type		0.315 ±0.031 in	(0.25 μm 0.01 mil)	20 × 700 μm 27.559 mil approx.	HL-C201A-SP2M (HL-C201AE-SP2M)	_	
Small beam spot type	i	15 ±1 mm	0.01 µm 0.0004 mil	ø30 µm ø1.181 mil approx.	HL-C201A-SP3 (HL-C201AE-SP3)		
Linear beam spot type		0.591 ±0.039 in	(0.25 µm 0.01 mil)	30 × 1,400 μm 55.118 mil approx.	HL-C201A-SP3M (HL-C201AE-SP3M)		
Small beam spot type	a re-Conse	At diffuse reflection mode	0.025 µm 0.001 mil	ø30 µm ø1.181 mil approx.	HL-C203B * (HL-C203BE*)	HL-C203F (HL-C203FE)	
Linear beam spot type		30 ±5 mm 1.181 ±0.197 in	(0.25 µm 0.01 mil)	30 × 1,200 μm 47.244 mil approx.	HL-C203B-MK * (HL-C203BE-MK *)	HL-C203F-MK (HL-C203FE-MK)	
Small beam spot type				ø70 μm ø2.756 mil approx.	HL-C205 (HL-C20	_	
Linear beam spot type		At diffuse reflection mode	0.05 µm 0.002 mil	70 × 1,000 μm 39.370 mil approx.	HL-C205 (HL-C20	5B-MK 5BE-MK)	
Small beam spot type		50 ±5 mm 1.969 ±0.197 in	(0.25 µm 0.01 mil)	ø70 μm ø2.756 mil approx.	HL-C205 (HL-C20	5C	
Linear beam spot type				70 × 1,000 μm 39.370 mil approx.	HL-C205 (HL-C20	5C-MK 5CE-MK)	
Small beam spot type				ø100 μm ø3.937 mil approx.	HL-C208 (HL-C20		
Linear beam spot type		At diffuse reflection mode	0.15 µm 0.006 mil	100 × 1,200 μm 47.244 mil approx.	HL-C208 (HL-C20	BB-MK 8BE-MK)	
Small beam spot type	A	85 ±20 mm 3.346 ±0.787 in	(0.25 μm 0.01 mil)	ø100 μm ø3.937 mil approx.	HL-C208 (HL-C20		
Linear beam spot type				100 × 1,200 μm 47.244 mil approx.	HL-C208 (HL-C20	BC-MK 8CE-MK)	
Small beam				ø80 µm	HL-C211B * (HL-C211BE *)	HL-C211F (HL-C211FE)	
spot type		At diffuse reflection mode	0.1 µm 0.004 mil	ø3.150 mil approx.	HL-C211C * (HL-C211CE *)	HL-C211F5 (HL-C211F5E)	
Linear beam		110 ±15 mm 4.331 ±0.591 in	(0.25 μm 0.01 mil)	80 × 1,700 μm	HL-C211B-MK * (HL-C211BE-MK *)	HL-C211F-MK (HL-C211FE-MK)	
spot type				66.929 mil approx.	HL-C211C-MK * (HL-C211CE-MK *)	HL-C211F5-MK (HL-C211F5E-MK)	
Small beam				ø250 μm	HL-C235BE *		
spot type		At diffuse reflection mode		ø9.843 mil approx.	HL-C235CE *		
Linear beam	4	350 ±50 mm 13.780 ±1.969 in	0.5 μm 0.02 mil	250 × 3,500 µm	HL-C235BE-MK *		
spot type				137.795 mil approx.	HL-C235CE-MK *		
Small beam spot type		At diffuse reflection mode		ø400 μm ø15.748 mil approx.	HL-C235	CE-W	
Linear beam spot type		350 ±200 mm 13.780 ±7.874 in	2 μm 0.079 mil	400 × 6,500 μm 255.905 mil approx.	HL-C235	CE-WMK	

Note: Exports of models with a minimum resolution of under 0.25 µm 0.010 mil fall under Japanese Export Control defined by "Foreign Exchange and Foreign Trade Act." However, export control does not apply to the models shown in parentheses on the condition that they are used in combination with a controller (e.g. **HL-C2CE**) to which the export control defined by "Foreign Exchange and Foreign Trade Act" does not apply. In such cases, the minimum resolution is 0.25 µm 0.010 mil. Please contact us for further details.

^{*}The product has acquired Korean S Mark certification.

ORDER GUIDE

Controllers

Тур	oe .	Appearance	Model No. (Note)
RS-232C	NPN output		HL-C2C * (HL-C2CE *)
compatible	PNP output	attention of the state of the s	HL-C2C-P * (HL-C2CE-P *)
Ethernet	NPN output		HL-C21C (HL-C21CE)
compatible	PNP output		HL-C21C-P (HL-C21CE-P)

Note: These products have been restricted for export in accordance with the "Foreign Exchange and Foreign Trade Act". However, by combining the parts listed in parentheses with sensor heads which are not restricted for export under the "Foreign Exchange and Foreign Trade Act", products for which the act does not restrict export can be provided. Please contact us for further details.
*The product has acquired Korean S Mark certification.

OPTIONS

Programmable display

It is possible to use the programmable display as an exclusive console which enables waveform display and condition setting by installing it in the screen data (free of charge) for **HL-C2**.

_												
	Desig	nation	Appearance	Model No.	LCD	Screen size	Power source	Communication port	Front panel color	SD memory card slot		
	GT12 -	GT12M	GT2	Recommended AIG12MQ02D	TFT monochrome						Pure black	
		GTIZIVI		AIG12MQ03D	(Note 4)	4.6 inch	24 V DC	RS-232C	Hairline silver			
		GT12G	GT12	AIG12GQ02D	TFT monochrome LCD (green backlight)		24 1 00	110-2020	Pure black			
		G112G	1-	AIG12GQ03D	(Note 4)				Hairline silver			

Notes: 1) The screen data differs depending on the language. Please download as necessary.

- 2) To install the screen data in the display, prepare a PC and a USB cable (A \Leftrightarrow mini-B connector type) separately.
- 3) The provided console screen application has no function to write the data into or download the data from an SD memory card.
- 4) The backlight color becomes fixed upon the installation of provided screen application.
- 5) Please refer to our website for more details about programmable display GT12.

Others

Designation	Appearance	Model No.	Description									
ND filter		HL-C2F01	When the amount of reflected light is large at the installed, reducing the amount of laser light to a measurement. (Light detection rate: 98 %) (Cannot be used with HL-C201□.)									
		HL-C2CCJ2 Length: 2 m 6.562 ft, Weight: 0.2 kg approx. HL-C2CCJ5 Length: 5 m 16.404 ft, Weight: 0.4 kg approx. Cabtyre cable with connector on Cable outer diameter: ø6.6 mm of Cable outer diameter										
		HL-C2CCJ5	Length: 5 m 16.404 ft, Weight: 0.4 kg approx.	Cabtyre cable with connector on both ends								
Sensor head extension cable		HL-C2CCJ10	Length: 10 m 32.808 ft, Weight: 0.7 kg approx.	Cable outer diameter: ø6.6 mm ø0.260 in Connector outer diameter: ø14.7 mm								
		HL-C2CCJ20	Length: 20 m 65.617 ft, Weight: 1.4 kg approx.	ø0.579 in max.								
		HL-C2CCJ30	Length: 30 m 98.425 ft, Weight: 2.0 kg approx.									
GT series connector cable for HL-C2		HL-C2GT-C3	Length: 3 m 9.843 ft	Cable to connect the programmable display GT12 and HL-C2 series controller								

Sensor heads

	Туре	Small beam spot type												
	E IEC/JIS conformed type	HL-C201A(E)	HL-C201A(E)-SP2	HL-C201A(E)-SP3	HL-C2	03B(E)	HL-C2	05B(E)	HL-C2	05C(E)	HL-C2	08B(E)	HL-C2	08C(E)
Item	FDA conformed type	HL-C201F(E)	_	_	HL-C2	03F(E)	-		-		_		_	
CE m	arking directive compliance					irective,								
Setup	mode (Note 2)		pecular reflection		Diffuse reflection	Specular reflection	Diffuse reflection	Specular reflection	Diffuse reflection	Specular reflection	Diffuse reflection	Specular reflection	Diffuse reflection	Specular reflection
Meas	urement center distance	10 mm 0.394 in	8 mm 0.315 in	15 mm 0.591 in	30 mm 1.181 in	26.4 mm 1.039 in	50 mm 1.969 in	46 mm 1.811 in	50 mm 1.969 in	46 mm 1.811 in	85 mm 3.346 in	81.4 mm 3.205 in	85 mm 3.346 in	81.4 mm 3.205 in
Meas	uring range (Note 3)	±1 mm ±0.039 in	±0.8 mm ±0.031 in	±1 mm ±0.039 in	±5 mm ±0.197 in	±4.6 mm ±0.181 in	±5 mm ±0.197 in	±5 mm ±0.197 in	±5 mm ±0.197 in	±5 mm ±0.197 in	±20 mm ±0.787 in	±6 mm ±0.236 in	±20 mm ±0.787 in	±6 mm ±0.236 in
Resol [Avera (Note	age number of samples]	/ HL-C2 0.04 µm 0.01 µm •HL-C20 / HL-C2	1A / HL-C201A- 01A-SP3 / HL-C 0.002 mil [256] 0.0004 mil [4,0 1AE / HL-C201, 01AE-SP3 / HL- 0.010 mil [256]	2201F: , 96] AE-SP2 -C201FE:	0.1 μm 0.004 mil [256] 0.025 μm 0.001 mil [4,096] -HL-C203BE -HL-C205BE / HL-C205CE: 0.6 μm 0.15 μ 0.15 μm 0.					n 0.024 i m 0.006 !08BE / n 0.024 i	8B / HL-C208C: 0.024 mil [256], 0.006 mil [4,096] 8BE / HL-C208CE: 0.024 mil [256], 0.0010 mil [4,096]			
Linea	rity (Note 6)	(HL-2	±0.02 % F.S. 01FE : ±0.025 %	5 F.S.)			±0.03	% F.S.			±0.03 % F.S.	±0.1 % F.S.	±0.03 % F.S.	±0.1 % F.S.
Temp	rerature characteristics	0.01 % F.S./°C (HL-201FE: 0.013 % F.S./°C)	0.02 %	F.S./°C					0.01 %	F.S./°C				
1 . 1 .			Red	semiconductor	laser (P	eak emi	ssion wa	avelengtl	h: 658 n	m 0.026	mil)			
Light	source	Max. outpu	ut: 0.1 mW Max. output: 0.3 mW Max. output: 1 mW Max. output: 1 mW Max. output: 5 mW					Max. outp	out: 1 mW	Max. outp	out: 5 mW			
	IEC/JIS conformed type	С	lass 1 (IEC / JIS	3)	Class 2 (IEC / JIS) Class 2 (IEC / JIS) Class 3R (IEC / JIS) Class 2 (IE					IEC / JIS)	Class 3R	(IEC / JIS)		
	FDA conformed type	Class 1 [IEC / JIS / FDA (Note 7)]			JIS), (2 (IEC / Class II DA)	IEC	ss 2 / JIS / Note 7)	IEC/	s 3R ' JIS / Note 7)		ss 2 JIS / Note 7)	[IEC	s 3R / JIS / Note 7)
Beam	size (Note 8)	ø20 μm ø0.78	7 mil approx.	ø30 µm ø1.1	81 mil a	prox.	ø70 µ	ım ø2.7	56 mil ap	prox.	ø100	µm ø3.9	37 mil a	pprox.
Recei	iving element				Li	near ima	age sens	sor						
ţ	Laser emission			Greei	n LED (li	ghts up	during la	aser emi	ssion)					
Indicator	Measuring range	(lights up when ne	ear the measureme	ent center distance,	blinks wh		v LED the meas	uring rang	ge, and lig	hts out w	hen outsid	de of the i	measurinç	g range.)
92	Protection			IP	67 (IEC) (exclud	ling the	connecto	or)					
sistar	Ambient temperature	0 to	+45 °C +32 to +	113 °F (No dew	condens	sation or	icing al	lowed), \$	Storage:	–20 to -	+70 °C –	4 to +15	8 °F	
al res	Ambient humidity			35	to 85 %	RH, Sto	rage: 35	to 85 %	RH					
nents	Ambient illuminance		In	candescent light	: 3,000 {	x or less	at the I	ight-rece	eiving fac	ce (Note	9)			
Environmental resistance	Vibration resistance	10 to 55 H	Hz (period: 1 mir	n.) frequency, 1.	5 mm 0.0	059 in do	ouble an	nplitude	in X,Y a	nd Z dire	ections fo	or two h	ours eac	:h
E	Shock resistance		196 m	/s² acceleration	(20 G ap	prox.) ir	n X,Y an	d Z dired	ctions th	ree time	s each			
Cable)			Cabtyre	cable, 0	.5 m 1.6	40 ft lor	g with c	onnecto	r				
Cable	extension		E	extension up to to	otal 30 n	n 98.425	ft is pos	ssible, w	ith optio	nal cable	е.			
Mater	ial		Enclosur	e: Die-cast alum	ninum, C	ase cov	er: Die-c	ast alum	ninum, F	ront cov	er: Glas	S		
Weigl	nt		250 g approx. (including cable)					300 g a	pprox. (including	g cable)		
Acces	ssory		La	aser warning lab	els (for a	pplicabl	e standa	ards and	regulati	ons): 1 s	set			
Notes:	1) Measuring conditions a	ro as follows un	loce othonwico e	nocified: connec	tion with	control	lor cupr	dy voltac	24\/	DC amb	niont tom	noratur	o. ∓30 °(

- Notes: 1) Measuring conditions are as follows unless otherwise specified: connection with controller, supply voltage: 24V DC, ambient temperature: +20 °C +68 °F, sampling cycle: 40 µs, average number of samples: 256 times, measurement center distance, measurement object: white ceramic [aluminum vapor deposition surface reflection mirror for HL-C201A(E) / HL-C201A(E)-SP2 / HL-C201F(E), clear glass for HL-C201A(E)-SP3], and digital measurement value.
 - 2) Use the external ND filter (optional) **HL-C2F01** in case the amount of reflected beam is too large on Specular Reflection installation. (Cannot be used with **HL-C201** ...)
 - 3) Measuring range at sampling periods of 20 µs and 10 µs is as follows.

Model	No.	HL-C201□	HL-C201□-SP2	HL-C201□-SP3	HL-C	203□	HL-C	205□	HL-C208□		
Setup mode		Specular reflection	Specular reflection	Specular reflection	Diffuse reflection	Specular reflection	Diffuse reflection	Specular reflection	Diffuse reflection	Specular reflection	
Complina	20 µs	+0.1 to +1.0 mm +0.004 to +0.039 in	+0.1 to +0.8 mm +0.004 to +0.031 in	+0.1 to +1.0 mm +0.004 to +0.039 in	0 to +5.0 mm 0 to +0.197 in	0 to +4.6 mm 0 to +0.181 in	+0.5 to +5.0 mm +0.020 to +0.197 in	+0.5 to +5.0 mm +0.020 to +0.197 in	0 to +20 mm 0 to +0.787 in	0 to +6.0 mm 0 to +0.236 in	
Sampling	10 µs	+0.8 to +1.0mm +0.031 to +0.039 in	+0.7 to +0.8mm +0.028 to +0.031 in	+0.8 to +1.0mm +0.031 to +0.039 in	+3.8 to +5.0mm +0.150 in to +0.197 in	+3.6 to +4.6mm +0.142 to 0.181 in	+4.7 to +5.0mm +0.185 to +0.197 in	+4.6 to +5.0mm +0.181 to +0.197 in	+18 to +20mm +0.709 to +0.787 in	Measurement not possible	

- 4) The P-P value for the deviation in the digital measurement values at the measurement center distance has been converted for the measurement center distance.
- 5) Exports of models with a minimum resolution of under 0.25 µm 0.010 mill fall under Japanese Export Control defined by "Foreign Exchange and Foreign Trade Act." These products are introduced to limited countries only. Please refer to 'PRECAUTIONS FOR PROPER USE' on p. 24.
- 6) Indicates error with respect to the ideal linear values for digital displacement output when standard objects were measured by our company. It may vary depending on the types of objects being measured.
- 7) FDA regulatory compliance is attained following the stipulations of Laser Notice No. 50 of FDA regulations.
- 8) This beam diameter is the size at the measurement center distance. These values were defined by using 1/e² (13.5 %) of the center light intensity. If there is a slight leakage of light outside the normal spot diameter and if the periphery surrounding the sensing point has a higher reflectivity than the sensing point itself, then the results may be affected.
- 9) Variance is ±0.03% F.S. or less depending on the ambient illuminance.

Sensor heads

$\overline{}$	Туре					Small bear	m spot type			
	을 IEC/JIS conformed type	HL-C2	11B(E)	HL-C2	11C(E)	HL-C	235BE	HL-C2	235CE	HL-C235CE-W
Item	FDA conformed type	conformed type HL-C211F(E) HL-C211F5(E) — —								_
CE m	arking directive compliance				r		RoHS Direct			
Setu	o mode (Note 2)	Diffuse reflection	Specular reflection	Diffuse reflection	Specular reflection	Diffuse reflection	Specular reflection	Diffuse reflection	Specular reflection	Diffuse reflection
Meas	surement center distance	110 mm 4.331 in	106.7 mm 4.201 in	110 mm 4.331 in	106.7 mm 4.201 in	350 mm 13.780 in	348 mm 13.701 in	350 mm 13.780 in	348 mm 13.701 in	350 mm 13.780 in
Meas	suring range (Note 3)	±15 mm ±0.591 in	±14.5 mm ±0.571 in	±15 mm ±0.591 in	±14.5 mm ±0.571 in	±50 mm ±1.969 in	±42 mm ±1.654 in	±50 mm ±1.969 in	±42 mm ±1.654 in	±200 mm ±7.874 in
[Ave	lution age number of samples] 4, 5)	HL-C21 0.1 μm •HL-C21 HL-C21	1B / HL-C21 1F5: 0.4 µm 0.004 mil [4,0 1BE / HL-C2 1F5E: 0.4 µn 0.01 mil [4,0	0.016 mil [25 096] 111CE / HL-C n 0.016 mil [2	56], 211FE /	2.0 µm 0.0	79 mil [256], ı	0.5 μm 0.020	mil [4,096]	8 µm 0.315 mil [256], 2 µm 0.079 mil [4,096]
Linea	urity (Note 6)				±0.03	% F.S.				±0.04 % F.S. (-200 to 0 mm -7.874 to 0 in), ±0.08 % F.S. (0 to +200 mm 0 to +7.874 in), (F.S. = ±200 mm ±7.874 in)
Temprerature characteristics 0.01 % F.S./°C										
Light	Red semiconductor laser (Peak emission wavelength: 658 nm 0.026 mil)							0.026 mil)		
Ligiti	Source	Max. outp	out: 1 mW	Max. outp	out: 5 mW	Max. out	out: 1 mW	Max. output: 5 mW		
	IEC/JIS conformed type	Class 2 (IEC / JIS)	Class 3R	(IEC / JIS)	Class 2 (IEC / JIS)	Class 3R	(IEC / JIS)	Class 3R (IEC / JIS)
	FDA conformed type	Class 2 (Class II (IEC / JIS), FDA)	Class 3R Class IIIa	(IEC / JIS), (FDA)	_		_	_	Class 3R IEC / JIS / FDA (Note 7)
Bear	n size (Note 8)		ø80 µm <mark>ø3.1</mark>	5 mil approx.	•	Q.	250 μm ø9.8	43 mil approx	ζ.	ø400 µm ø15.748 mil approx.
Rece	iving element					Linear ima	age sensor			
ator	Laser emission				Green L	ED (lights up	during laser e	emission)		
Indicator	Measuring range	(lights up whe	n near the mea	surement cente	er distance, blin		w LED the measuring	range, and light	s out when ou	tside of the measuring range.)
nce	Protection				IP67	(IEC) (exclud	ding the conn	ector)		
sista	Ambient temperature	0	to +45 °C +3	32 to +113 °F	(No dew cor	ndensation or	icing allowed	d), Storage: -	20 to +70 °C	-4 to +158 °F
alre	Ambient humidity				35 to 8	5 % RH, Sto	rage: 35 to 85	5 % RH		
Environmental resistance	Ambient illuminance			Incandes	scent light: 3,	000 {x or less	at the light-r	eceiving face	(Note 9)	
iron	Vibration resistance	10 to 5	55 Hz (period	: 1 min.) freq	uency, 1.5 m	m 0.059 in de	ouble amplitu	de in X,Y and	d Z directions	s for two hours each
Ш	Shock resistance			196 m/s ² acc	eleration (20	G approx.) ii	n X,Y and Z d	lirections thre	e times each	1
Cabl	9				Cabtyre cal	ole, 0.5 m 1.6	640 ft long wit	h connector		
Cabl	e extension			Extensi	on up to total	30 m 98.425	ft is possible	e, with optiona	al cable.	
Mate	rial		En	closure: Die-	cast aluminu	m, Case cov	er: Die-cast a	luminum, Fro	ont cover: Gla	ass
Weig	ht	30	0 g approx. (ncluding cab	ole)	45	0 g approx. (including cab	le)	300 g approx. (including cable)
Acce	ssory					Laser warnir	ng label: 1 set			
NI-4	. 4\ \ \ 4 = ==	£.11						H 041/ D	O	

Notes: 1) Measuring conditions are as follows unless otherwise specified: connection with controller, supply voltage: 24V DC, ambient temperature: +20 °C +68 °F, sampling cycle: 40 µs, average number of samples: 256 times, measurement center distance, measurement object: white ceramic, and digital measurement value.

- 2) Use the external ND filter (optional) HL-C2F01 in case the amount of reflected beam is too large on Specular Reflection installation.
- 3) Measuring range at sampling periods of 20 μs and 10 μs is as follows.

Model	No.	HL-C	211□	HL-C	235□	HL-C235CE-W
Setup n	node	Diffuse reflection Specular reflection		Diffuse reflection	Specular reflection	Diffuse reflection
Campling	20 µs	+0.5 to +15.0 mm +0.020 to +0.591 in	+0.5 to +14.5 mm +0.020 to +0.571 in	0 to +50 mm 0 to +1.969 in	0 to +42 mm 0 to +1.654 in	-70 to +200 mm -2.756 to +7.874 in
Sampling	10 µs	+12.5 to +15.0 mm +0.492 to +0.591 in	+12.5 to +14.5 mm +0.492 to +0.571 in	+36 to +50 mm +1.417 to +1.969 in	+36 to +42 mm +1.417 to +1.654 in	+100 to +200 mm +3.937 to +7.874 in

- 4) The P-P value for the deviation in the digital measurement values at the measurement center distance has been converted for the measurement center distance.
- 5) Exports of models with a minimum resolution of under 0.25 µm 0.010 mil fall under Japanese Export Control defined by "Foreign Exchange and Foreign Trade Act." These products are introduced to limited countries only. Please refer to 'PRECAUTIONS FOR PROPER USE' on p. 24.
- 6) Indicates error with respect to the ideal linear values for digital displacement output when standard objects were measured by our company. It may vary depending on the types of objects being measured.
- 7) FDA regulatory compliance is attained following the stipulations of Laser Notice No. 50 of FDA regulations.
- 8) This beam diameter is the size at the measurement center distance. These values were defined by using 1/e² (13.5 %) of the center light intensity. If there is a slight leakage of light outside the normal spot diameter and if the periphery surrounding the sensing point has a higher reflectivity than the sensing point itself, then the results may be affected.
- 9) Variance is ±0.03% F.S. or less (±0.08% F.S. or less for **HL-C235CE-W**) depending on the ambient illuminance.

Sensor heads

	Туре				Line	ar bea	m spot	type						
	E IEC/JIS conformed type	HL-C201A(E)-MK	C201A(E)-MK HL-C201A(E)-SP2M HL-C201A(E)-SP3M HL-C203B(E)-MK HL-C205B(E)-MK HL-C205C(E)-MK							HL-C208	B(E)-MK	HL-C208	BC(E)-MK	
Item	FDA conformed type	HL-C201F(E)-MK	_	_	HL-C203	F(E)-MK	-	_	_	_	_	_	_	_
	arking directive compliance						RoHS D	1	1		ı			
Setup	o mode (Note 2)		pecular reflection	n	Diffuse reflection	Specular reflection	Diffuse reflection	Specular reflection	Diffuse reflection	Specular reflection	Diffuse reflection	Specular reflection	Diffuse reflection	Specular reflection
Meas	surement center distance	10 mm 0.394 in	8 mm 0.315 in	15 mm 0.591 in	30 mm 1.181 in	26.4 mm 1.039 in	50 mm 1.969 in	46 mm 1.811 in	50 mm 1.969 in	46 mm 1.811 in	85 mm 3.346 in	81.4 mm 3.205 in	85 mm 3.346 in	81.4 mm 3.205 in
Meas	suring range (Note 3)	±1 mm ±0.039 in	±0.8 mm ±0.031 in	±1 mm ±0.039 in	±5 mm ±0.197 in	±4.6 mm ±0.181 in	±5 mm ±0.197 in	±5 mm ±0.197 in	±5 mm ±0.197 in	±5 mm ±0.197 in	±20 mm ±0.787 in	±6 mm ±0.236 in	±20 mm ±0.787 in	±6 mm ±0.236 in
[Aver	lution age number of samples] 4, 5)	/ HL-C201A 0.04 µm 0.0 0.01 µm 0.0 •HL-C201AE	MK / HL-C201A -SP3M / HL-C2 02 mil [256], 004 mil [4,096] -MK / HL-C201 E-SP3M / HL-C	01F-MK: AE-SP2M	•HL-C203B-MK /HL-C203F-MK: 0.1 μm 0.004 mil [256] 0.025 μm 0.001 mil [4,096] •HL-C203E-MK /HL-C203BE-MK /HL-C203FE-MK 0.25 μm 0.010 mil [256] 0.25 μm 0.010 mil [256]				•HL-C208B-MK / HL-C208C-MK: 0.6 µm 0.024 mil [256], 0.15 µm 0.006 mil [4,096] •HL-C208BE-MK / HL-C208CE-MK: 0.6 µm 0.024 mil [256], 0.25 µm 0.010 mil [4,096]			96]		
Linea	rity (Note 6)	(HL-201	±0.02 % F.S. FE-MK : ±0.025	% F.S.)			±0.03	% F.S.			±0.03 % F.S.	±0.1 % F.S.	±0.03 % F.S.	±0.1 % F.S.
Temp	orerature characteristics	0.01 % F.S./°C (HL-201FE-MK: 0.013 % F.S./°C)	0.02 %	F.S./°C					0.01 %	F.S./°C				
Limba			Red	semiconductor	laser (P	eak emi	ssion wa	avelengtl	h: 658 n	m 0.026	mil)			
Light	source	Max. outpu	ut: 0.1 mW	Max. output: 0.3 mW	Max. outp	out: 1 mW	Max. out	out: 1 mW	Max. outp	out: 5 mW	Max. outp	out: 1 mW	Max. outp	out: 5 mW
	IEC/JIS conformed type	С	lass 1 (IEC / JIS	S)	Class 2 (IEC / JIS) Class 2 (IEC / JIS) Class 3R (IEC / JIS) Class 2 (IEC / JIS) Class 3R						Class 3R	(IEC / JIS)		
	FDA conformed type	Class 1 [IEC / JIS / FDA (Note 7)]			JIS), C	2 (IEC / Class II DA)	IEC	ss 2 / JIS / Note 7)	Clas IEC / FDA (N	JIS /	Clas IEC / FDA (N	JIS /		
Beam	n size (Note 8)	20 × 7 0.787 × 27.55		30 × 1,400 μm 1.181 × 55.118 mil approx.	30 × 1, 1.181 × 47.24	200 µm 14 mil approx.	2.756	70 × 1, 5 × 39.37	000 µm 70 mil ap	prox.		100 × 1 ′ × 47.24		
Rece	iving element				Li	near ima	age sens	or						
tor	Laser emission			Green	n LED (li	ghts up	during la	aser emi	ssion)					
Indicator	Measuring range	(lights up when ne	ear the measureme	nt center distance,	blinks wh		v LED the meas	uring rang	ge, and lig	hts out w	hen outsid	de of the r	neasuring	g range.)
9	Protection			IP	67 (IEC) (exclud	ling the	connecto	or)					
Environmental resistance	Ambient temperature	0 to	+45 °C +32 to +	113 °F (No dew	condens	sation or	icing all	owed), S	Storage:	–20 to -	+70 °C −	4 to +15	8 °F	
al res	Ambient humidity			35 1	to 85 %	RH, Sto	rage: 35	to 85 %	RH					
nent	Ambient illuminance		Inc	candescent light	: 3,000 ℓ	x or less	at the li	ight-rece	eiving fac	e (Note	9)			
ironn	Vibration resistance	10 to 55 H	Hz (period: 1 mir	n.) frequency, 1.5	5 mm 0.0	059 in do	ouble an	nplitude	in X,Y a	nd Z dire	ections fo	or two h	ours eac	h
Env	Shock resistance		196 m	/s² acceleration	(20 G ap	prox.) ir	n X,Y an	d Z dire	ctions th	ree time	s each			
Cable	•			Cabtyre	cable, 0	.5 m 1.6	40 ft lon	g with c	onnecto	r				
Cable	e extension		E	xtension up to to	otal 30 n	า 98.425	ft is pos	ssible, w	ith optio	nal cable	е.			
Mate	rial		Enclosur	e: Die-cast alum	inum, C	ase cov	er: Die-c	ast alum	ninum, F	ront cov	er: Glas	s		
Weigl	ht		250 g approx. (including cable)					300 g a	pprox. (including	g cable)		
Acces	ssory		La	ser warning lab	els (for a	pplicabl	e standa	ards and	regulati	ons): 1 s	set			
Notoo	1) Magazina conditions a	ro oo followo un	loop othorwing o	nooified: connec	tion with	oontrol	lor ounr	dy voltoe	20: 24\/ 1	C amb	siont tom	norotur	- ±30 °0	

- Notes: 1) Measuring conditions are as follows unless otherwise specified: connection with controller, supply voltage: 24V DC, ambient temperature: +20 °C +68 °F, sampling cycle: 40 µs, average number of samples: 256 times, measurement center distance, measurement object: white ceramic [aluminum vapor deposition surface reflection mirror for HL-C201A(E)-MK / HL-C201A(E)-SP2M / HL-C201F(E)-MK, clear glass for HL-C201A(E)-SP3M], and digital measurement value.
 - 2) Use the external ND filter (optional) **HL-C2F01** in case the amount of reflected beam is too large on Specular Reflection installation. (Cannot be used with **HL-C201**...)
 - 3) Measuring range at sampling periods of 20 μs and 10 μs is as follows.

Model	No.	HL-C201□-MK	HL-C201 -SP2M	HL-C201 -SP3M	HL-C20	3□-MK	HL-C20)5□-MK	HL-C208□-MK		
Setup mode		Specular reflection	Specular reflection	Specular reflection	Diffuse reflection	Specular reflection	Diffuse reflection	Specular reflection	Diffuse reflection	Specular reflection	
Compling	20 µs	+0.1 to +1.0 mm +0.004 to +0.039 in	+0.1 to +0.8 mm +0.004 to +0.031 in	+0.1 to +1.0 mm +0.004 to +0.039 in	0 to +5.0 mm 0 to +0.197 in	0 to +4.6 mm 0 to +0.181 in	+0.5 to +5.0 mm +0.020 to +0.197 in	+0.5 to +5.0 mm +0.020 to +0.197 in	0 to +20 mm 0 to +0.787 in	0 to +6.0 mm 0 to +0.236 in	
Sampling	10 µs	+0.8 to +1.0mm +0.031 to +0.039 in	+0.7 to +0.8mm +0.028 to +0.031 in	+0.8 to +1.0mm +0.031 to +0.039 in	+3.8 to +5.0mm +0.150 in to +0.197 in	+3.6 to +4.6mm +0.142 to 0.181 in	+4.7 to +5.0mm +0.185 to +0.197 in	+4.6 to +5.0mm +0.181 to +0.197 in	+18 to +20mm +0.709 to +0.787 in	Measurement not possible	

- 4) The P-P value for the deviation in the digital measurement values at the measurement center distance has been converted for the measurement center
- 5) Exports of models with a minimum resolution of under 0.25 µm 0.010 mill fall under Japanese Export Control defined by "Foreign Exchange and Foreign Trade Act." These products are introduced to limited countries only. Please refer to 'PRECAUTIONS FOR PROPER USE' on p. 24.
- 6) Indicates error with respect to the ideal linear values for digital displacement output when standard objects were measured by our company. It may vary depending on the types of objects being measured.
- 7) FDA regulatory compliance is attained following the stipulations of Laser Notice No. 50 of FDA regulations.
- 8) This beam diameter is the size at the measurement center distance. These values were defined by using 1/e² (13.5 %) of the center light intensity. If there is a slight leakage of light outside the normal spot diameter and if the periphery surrounding the sensing point has a higher reflectivity than the sensing point itself, then the results may be affected.
- Variance is ±0.03% F.S. or less depending on the ambient illuminance.

Sensor heads

Туре						Linear bear	m spot type			
E IEC/JIS conformed type				C(E)-MK	HL-C235BE-MK HL-C235CE-M		5CE-MK	HL-C235CE-WMK		
Item FDA conformed type		HL-C211	F(E)-MK	HL-C211	F5(E)-MK	_	_	_	_	_
CE n	narking directive compliance				1	,	RoHS Direct			_
Setu	ip mode (Note 2)	Diffuse reflection	Specular reflection	Diffuse reflection	Specular reflection	Diffuse reflection	Specular reflection	Diffuse reflection	Specular reflection	Diffuse reflection
Mea	surement center distance	110 mm 4.331 in	106.7 mm 4.201 in	110 mm 4.331 in	106.7 mm 4.201 in	350 mm 13.780 in	348 mm 13.701 in	350 mm 13.780 in	348 mm 13.701 in	350 mm 13.780 in
Mea	suring range (Note 3)	±15 mm ±0.591 in	±14.5 mm ±0.571 in	±15 mm ±0.591 in	±14.5 mm ±0.571 in	±50 mm ±1.969 in	±42 mm ±1.654 in	±50 mm ±1.969 in	±42 mm ±1.654 in	±200 mm ±7.874 in
Resolution [Average number of samples] (Note 4, 5)		/ HL-C211F 0.4 µm 0.0 •HL-C211BI / HL-C211F	-MK / HL-C21 F-MK / HL-C2 16 mil [256], (E-MK / HL-C FE-MK / HL-C 16 mil [256], (11F5-MK: 0.1 µm 0.004 211CE-MK 2211F5E-MK	:	2.0 µm 0.0	79 mil [256],	0.5 μm 0.020	mil [4,096]	8 µm 0.315 mil [256], 2 µm 0.079 mil [4,096]
Linearity (Note 6)		±0.03 % F.S.						±0.04 % F.S. (-200 to 0 mm -7.874 to 0 in), ±0.08 % F.S. (0 to +200 mm 0 to +7.874 in), (F.S. = ±200 mm ±7.874 in)		
Tem	prerature characteristics		0.01 % F.S./°C							
Limb	t 00.000	Red semiconductor laser (Peak emission wavelength: 658 nm 0.026 mil)								
Ligh	t source	Max. output: 1 mW Max. output: 5 mW		Max. output: 1 mW Max. output: 5		out: 5 mW	Max. output: 5 mW			
	IEC/JIS conformed type	Class 2 (IEC / JIS)	Class 3R	(IEC / JIS)	Class 2 (IEC / JIS)	Class 3R	(IEC / JIS)	Class 3R (IEC / JIS)
	FDA conformed type	Class 2 (IEC / JIS), Class II (FDA)		Class 3R (IEC / JIS), Class IIIa (FDA)		_	_	_	_	Class 3R [IEC / JIS / FDA (Note 7)]
Beam size (Note 8)		80 × 1,700 μm 3.150 × 66.929 mil approx.			9	250 × 3 9.843 × 137.7	,500 µm 95 mil approx	(.	400 × 6,500 μm 15.748 × 255.905 mil approx.	
Rece	eiving element	Linear image sensor								
ភ្នំ Laser emission		Green LED (lights up during laser emission)								
Indicator	Measuring range	Yellow LED (lights up when near the measurement center distance, blinks when within the measuring range, and lights out when outside of the measuring range.								
a)c	Protection	IP67 (IEC) (excluding the connector)								
istar	Ambient temperature	0	0 to +45 °C +32 to +113 °F (No dew con			ndensation or icing allowed), Storage: -20 to +70 °C -4 to +158 °F				
E E	Ambient humidity	35 to 85 % RH, Storage: 35 to 85 % RH								
nenta	Ambient illuminance			Incandes	scent light: 3,	000 {x or less	at the light-r	eceiving face	(Note 9)	
Environmental resistance	Vibration resistance	10 to 55 Hz (period: 1 min.) frequency, 1.5 mm 0.059 in double amplitude in X,Y and Z directions						s for two hours each		
En	Shock resistance	196 m/s ² acceleration (20 G approx.) in X,Y and Z directions three times each						า		
Cabl	le	Cabtyre cable, 0.5 m 1.640 ft long with connector								
Cable extension				Extensi	on up to total	30 m 98.425	ft is possible	e, with option	al cable.	
Material			En	closure: Die-	-cast aluminu	m, Case cov	er: Die-cast a	luminum, Fro	nt cover: Gla	ass
Weight		300 g approx. (including cable) 450 g approx. (including cable)				300 g approx. (including cable)				
Acce	essory		Laser warning labels (for applicable standards and regulations): 1 set							
Notes: 1) Measuring conditions are as foll			unless other	wise specific	d: connection	with control	lor cupply yo	Itago: 24V Di	ambient to	omporature: ±20 °C

Notes: 1) Measuring conditions are as follows unless otherwise specified: connection with controller, supply voltage: 24V DC, ambient temperature: +20 °C +68 °F, sampling cycle: 40 µs, average number of samples: 256 times, measurement center distance, measurement object: white ceramic, and digital measurement value.

- 2) Use the external ND filter (optional) HL-C2F01 in case the amount of reflected beam is too large on Specular Reflection installation.
- 3) Measuring range at sampling periods of 20 μs and 10 μs is as follows.

Model No.		HL-C21	I1□-MK	HL-C23	HL-C235CE-WMK	
Setup mode		Diffuse reflection	Specular reflection	Diffuse reflection	Specular reflection	Diffuse reflection
Complina	20 µs	+0.5 to +15.0 mm +0.020 to +0.591 in	+0.5 to +14.5 mm +0.020 to +0.571 in	0 to +50 mm 0 to +1.969 in	0 to +42 mm 0 to +1.654 in	-70 to +200 mm -2.756 to +7.874 in
Sampling	10 µs	+12.5 to +15.0 mm +0.492 to +0.591 in	+12.5 to +14.5 mm +0.492 to +0.571 in	+36 to +50 mm +1.417 to +1.969 in	+36 to +42 mm +1.417 to +1.654 in	+100 to +200 mm +3.937 to +7.874 in

- 4) The P-P value for the deviation in the digital measurement values at the measurement center distance has been converted for the measurement center distance.
- 5) Exports of models with a minimum resolution of under 0.25 µm 0.010 mill fall under Japanese Export Control defined by "Foreign Exchange and Foreign Trade Act." These products are introduced to limited countries only. Please refer to 'PRECAUTIONS FOR PROPER USE' on p. 24.
- 6) Indicates error with respect to the ideal linear values for digital displacement output when standard objects were measured by our company. It may vary depending on the types of objects being measured.
- 7) FDA regulatory compliance is attained following the stipulations of Laser Notice No. 50 of FDA regulations.
- 8) This beam diameter is the size at the measurement center distance. These values were defined by using 1/e² (13.5 %) of the center light intensity. If there is a slight leakage of light outside the normal spot diameter and if the periphery surrounding the sensing point has a higher reflectivity than the sensing point itself, then the results may be affected.
- 9) Variance is ±0.03% F.S. or less (±0.08% F.S. or less for **HL-C235CE-WMK**) depending on the ambient illuminance.

Controllers

/		Туре	RS-232C compatible	Ethernet compatible				
	્ર ટું	NPN output type	HL-C2C(E)	HL-C21C(E)				
Item	Model No.	PNP output type	HL-C2C(E)-P	HL-C21C(E)-P				
CE m		ctive compliance	EMC Directive,	RoHS Directive				
Conr	nectable se	ensor head	Number of connectate	ole units: Max. 2 units				
Supp	oly voltage		24 V DC ±10 % including ripple 0.5 V (P-P)					
	ent consun	nption	500 mA approx. at 2 sensor heads connected, 350 mA approx. at 1 sensor head connected					
	pling cycle			, 200 µs, 400 µs, 1 ms, 2 ms				
	Voltage (I	Note 2)	Voltage output scale: -5 to $+5$ V/F.S. (initial value) Output range during normal status: -10.0 to $+10.0$ V Output at abnormal status: -10.8 V or $+10.8$ V Resolution: 2 mV, Linearity: ±0.05 % F.S. Max. 2 mA, output impedance 50 Ω , Response delay time: 1.5 μ s/V approx.					
Analog output	Current (I	Note 3)	Current output scale: 4 to 20 mA/F.S. (initial value) Output range during normal status: 2 to 24 mA Output at abnormal status: 1 mA or 25 mA Resolution: 3 μΑ, Linearity: ±0.05% F.S. Load impedance: 250 Ωmax., Response delay time: 10 μs approx.					
Alarr	m output		<npn output="" type=""> NPN open-collector transistor • Maximum sink current: 100 mA • Applied voltage: 30 V DC or less [between alarm output and Common(–)] • Residual voltage: 1 V or less (at 100 mA sink current)</npn>	<pnp output="" type=""> PNP open-collector transistor • Maximum source current: 100 mA • Applied voltage: 30 V DC or less (between alarm output and +V) • Residual voltage: 1 V or less (at 100 mA source current)</pnp>				
	Output op	peration	Opened when the amou	unt of light is insufficient				
	Short-circ	uit protection	Incorp	orated				
	ment outpi	ut	<npn output="" type=""> NPN open-collector transistor • Maximum sink current: 100 mA • Applied voltage: 30 V DC or less [between judgment output to Common(–)] • Residual voltage: 1 V or less (at 100 mA sink current)</npn>	<pnp output="" type=""> PNP open-collector transistor • Maximum source current: 100 mA • Applied voltage: 30 V DC or less (between judgment output to +V) • Residual voltage: 1 V or less (at 100 mA source current)</pnp>				
	Output op	peration	Opened at output operation					
Short-circuit protection		uit protection	Incorp	orated				
Strok	Strobe output		<npn output="" type=""> NPN open-collector transistor • Maximum sink current: 100 mA • Applied voltage: 30 V DC or less [between strobe output to Common(–)] • Residual voltage: 1 V or less (at 100 mA sink current)</npn>	<pnp output="" type=""> PNP open-collector transistor • Maximum source current: 100 mA • Applied voltage: 30 V DC or less (between strobe output to +V) • Residual voltage: 1 V or less (at 100 mA source current)</pnp>				
	Output op	eration	Opened at data determination					
	Short-circ	uit protection	Incorp	orated				
Remote interlock input		ck input	<npn output="" type=""> Laser emission is delayed when connected to Common (–). Laser emission stop at open Applied voltage: 30 V DC or less (Leak current: 0.1 mA or less)</npn>	<pnp output="" type=""> Laser emission is delayed when connected to IL (+). Laser emission stop at open Applied voltage: 30 V DC or less (Leak current: 0.1 mA or less)</pnp>				
Lase	r control in	put	<npn output="" type=""> Laser emission is stopped when connected to Common (–). Laser is emitted immediately after opened. Applied voltage: 30 V DC or less (Leak current: 0.1 mA or less)</npn>	<pnp output="" type=""> Laser emission is stopped when connected to external power (+) Laser is emitted immediately after opened. Applied voltage: 30 V DC or less (Leak current: 0.1 mA or less</pnp>				
Zero set input			<npn output="" type=""> Zero set is ON when connected with Common (–). Zero set turns to OFF after continuously connected to Common (–) for one second. Applied voltage: 30 V DC or less (Leak current: 0.1 mA or less)</npn>	<pnp output="" type=""> Zero set is ON when connected with external power (+). Zero set turns to OFF after continuously connected to external power (+) for one second. Applied voltage: 30 V DC or less (Leak current: 0.1 mA or less</pnp>				
Timing input			<npn output="" type=""> ON at/during connection to Common (–) (depending on analysis mode) Applied voltage: 30 V DC or less (Leak current: 0.1 mA or less)</npn>	<pnp output="" type=""> ON at/during connection to external power (+) (depending on analysis mode) Applied voltage: 30 V DC or less (Leak current: 0.1 mA or less</pnp>				
Reset input			<npn output="" type=""> Reset is done when connected to Common (–). Applied voltage: 30 V DC or less (Leak current: 0.1 mA or less)</npn>	<pnp output="" type=""> Reset is done when connected to external power (+). Applied voltage: 30 V DC or less (Leak current: 0.1 mA or less</pnp>				
Mem	ory change	e input	<npn output="" type=""> Memory is specified when connected to Common (–). Applied voltage: 30 V DC or less (Leak current: 0.1 mA or less) Applied voltage: 30 V DC or less (Leak current: 0.1 mA or less)</npn>					
RS-2	232C interfa	ace	Baud rate 9,600, 19,200, 38,400, 115,200 bit/s	_				
Ethe	rnet interfa	ce (Note 4)	_	IEEE802.3u, 10BASE-T/100BASE-TX RJ45 Compatible protocols: iQSS-compatible proprietary protocol, MC protocol, MEWTOCOL				
USB	interface		USB 2.0 full speed (USB 1.1 compatible) compliant					
	ng/Data Di	enlav	GT12 Programmable Display (optional)					

Controllers

		Туре	RS-232C compatible	Ethernet compatible		
	No.	NPN output type	HL-C2C(E)	HL-C21C(E)		
Iter	Model No.	PNP output type	HL-C2C(E)-P	HL-C21C(E)-P		
	Power		Green LED (light	s up at power on)		
ō	Sensor head A Laser radiation		Green LED (lights up during or immediately before laser emission of sensor head A)			
Indicator	Sensor head B Laser radiation		Green LED (lights up during or immediately before laser emission of sensor head B)			
	Alarm 1		Red LED (lights up when OUT1 can not be measured due to insufficient amount of light)			
	Alarm 2		Red LED (lights up when OUT2 can not be measured due to insufficient amount of light)			
tance	Ambient temperature		0 to +50 °C +32 to +122 °F (No dew condensation or icing allowed), Storage: –20 to +70 °C –4 to +158 °F			
Environmental resistance	Ambient humidity		35 to 85 %RH			
nment	Vibration resistance		10 to 55 Hz frequency (period: 1 min.), 0.75 mm 0.030 in double amplitude in X, Y and Z directions for 30 min. each			
Envir	Shock resistance		196 m/s² acceleration (20G approx.) in X, Y, and Z directions three times each			
Material			Case: Polycarbonate			
Wei	Weight		450 g approx.			
Accessory			CD-ROM: 1 pc., USB cable (2 m 6.562 ft long): 1 pc., Short bracket: 1 pc. CD-ROM: 1 pc., USB cable (2 m 6.562 ft long): 1 pc., S Ferrite core (E04SR200935A made by Seiwa Electric M			

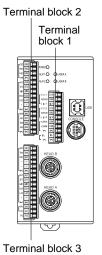
Notes: 1) HL-C2C(-P) / HL-C21C(-P) are restricted for export in accordance with the "Foreign Exchange and Foreign Trade Law". These products are introduced to limited countries only. Please refer to 'PRECAUTIONS FOR PROPER USE' on p. 24.

- 2) The linearity is F.S.=20 V to digital measurement value. Response delay time is the period after update of measurement value.
- 3) The linearity is F.S.=16 mA to digital measurement value. Response delay time is the period after update of measurement value.
- 4) For Ethernet communication settings of **HL-C21C(E)** (-**P**), **Configurator WD** (Ethernet communication setting tool, Ver. 1.62 or later) is required. Please download it from our website for use.

Terminal block 2

I/O CIRCUIT AND WIRING DIAGRAMS

Terminal arrangement



Ter	Terminal block 1				
Tern	ninal	Function			
NPN	PNP	Function			
(V)1	Analog voltage output (for OUT1)			
AG	ND	Analog ground			
(I))1	Analog current output (for OUT1)			
(V)2	Analog voltage output (for OUT2)			
AG	ND	Analog ground			
(I))2	Analog current output (for OUT2)			
LS	RA	Laser control input (for Head A) Laser stop during short circuit			
LS	RB	Laser control input (for Head B) Laser stop during short circuit			
(-	-)	Common (–)			
IL	IL-	Remote interlock Laser stop when opened.			
(-)	IL+	Remote interlock common			

Terminal		Function	
NPN	PNP	Function	
ZS	52	Zero set input (for OUT2) ON during short circuit (Note 1)	
TN	/12	Timing input (for OUT2) ON during short circuit	
R	S2	Reset input (for OUT2) ON during short circuit	
(-	-)	Common (–)	
Al	_2	Alarm output (for OUT2)	
ST2		Strobe output (for OUT2)	
HI2		Judgment HI output (for OUT2)	
GO2 LO2		Judgment GO output (for OUT2)	
		Judgment LO output (for OUT2)	
		Reserved terminal (Note 2)	
(-)	(+)	Common (–) / Common (+)	
MO		Memory change (16 ways)	
M1			
M2			
МЗ			

Notes: 1) Turn off the terminal in case short circuit lasts for more than one second.

Common (-)

2) Do not connect anything to the reserved terminals.

Terminal block 3

Terminal		Function	
NPN	PNP	runction	
ZS	S1	Zero set input (for OUT1) ON during short circuit (Note 1)	
TN	/ 11	Timing input (for OUT1) ON during short circuit	
R	S1	Reset input (for OUT1) ON during short circuit	
	•	Reserved terminal (Note 2)	
	•	Reserved terminal (Note 2)	
(-	-)	Common (–)	
Al	L1	Alarm output (for OUT1)	
S	Γ1	Strobe output (for OUT1)	
Н	I 1	Judgment HI output (for OUT1)	
G)1	Judgment GO output (for OUT1)	
LO1		Judgment LO output (for OUT1)	
•		Reserved terminal (Note 2)	
(-)	(+)	Common (–) / Common (+)	
24V		24 V DC input for power supply	
0	V	Power supply ground 0 V	
FG		Frame ground	

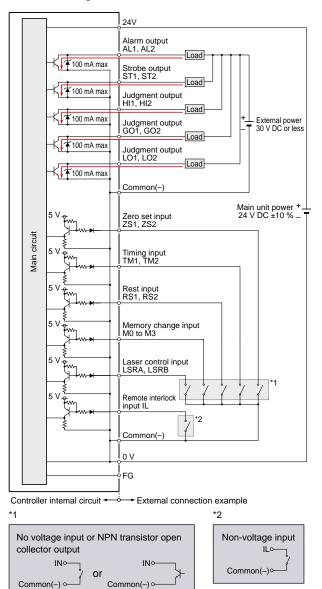
Notes: 1) Turn off the terminal in case short circuit lasts for more than one second.

2) Do not connect anything to the reserved terminals.

I/O CIRCUIT AND WIRING DIAGRAMS

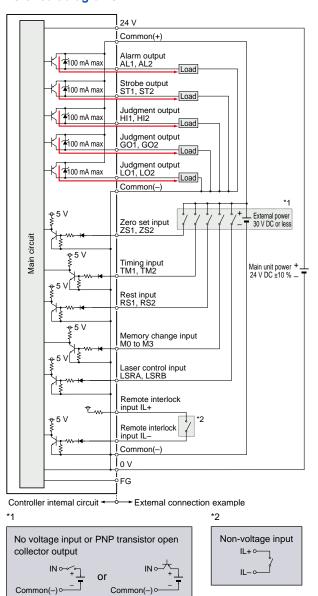
NPN output type

I/O circuit diagrams

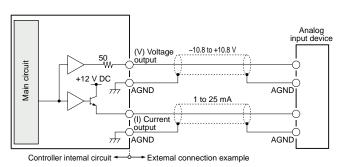


PNP output type

I/O circuit diagrams



Analog output (Common in NPN output type and PNP output type)



Notes: 1) Do not short-circuit analog output terminals or apply voltage to them.

2) Use shielded wires for analog outputs.

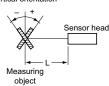
SENSING CHARACTERISTICS (TYPICAL)

HL-C201A HL-C201F

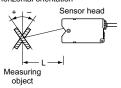
Correlation between measuring distance and error characteristics

Setup mode: Specular reflection

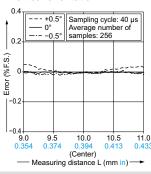
Aluminum vapor deposition surface reflection mirror (0°, ±0.5°) Vertical orientation



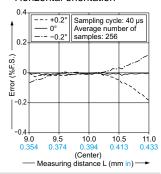
Aluminum vapor deposition (0°. ±0.2°)



Vertical orientation



· Horizontal orientation

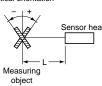


HL-C201A-SP2

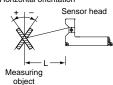
Correlation between measuring distance and error characteristics

Setup mode: Specular reflection

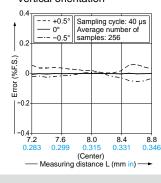
Aluminum vapor deposition surface reflection mirror $(0^{\circ}, \pm 0.5^{\circ})$ Vertical orientation



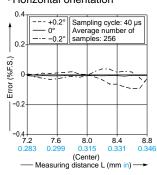
Aluminum vapor deposition surface reflection mirror $(0^{\circ}, \pm 0.2^{\circ})$



Vertical orientation



Horizontal orientation



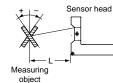
HL-C201A-SP3

Correlation between measuring distance and error characteristics

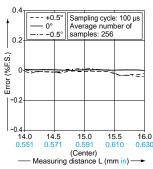
Setup mode: Specular reflection

Glass (0°, ±0.5°) Vertical orientation Measuring

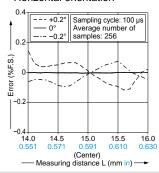
Glass (0°, ±0.2°) Horizontal orientation



Vertical orientation



· Horizontal orientation



HL-C203B HL-C203F

object

Correlation between measuring distance and error characteristics

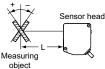
Setup mode: Diffuse reflection

White ceramic (0°, ±10°) Vertical orientation

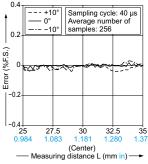
Sensor head

Measuring object

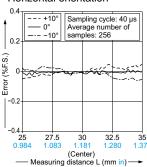
White ceramic (0°, ±10°) Horizontal orientation



Vertical orientation



· Horizontal orientation

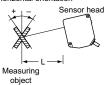


Setup mode: Specular reflection

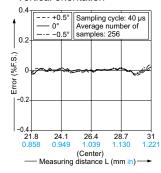
Aluminum vapor deposition (0°, ±0.5°) Vertical orientation

Sensor head Measuring

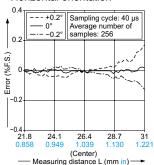
Aluminum vapor deposition (0°, ±0.2°) Horizontal orientation



Vertical orientation



Horizontal orientation



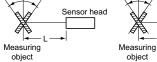
SENSING CHARACTERISTICS (TYPICAL)

HL-C205B HL-C205C

Correlation between measuring distance and error characteristics

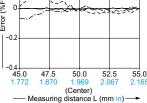
Setup mode: Diffuse reflection

White ceramic (0°, ±10°) Horizontal orientation White ceramic (0°, ±10°) Vertical orientation Sensor head



0.4 Sampling cycle: 40 µs Average number of samples: 256 (%F.S.) Error (

Vertical orientation



· Horizontal orientation Sampling cycle: 40 µs Average number of samples: 256 +10° −10° (%F.S.) 3 Error (-0.4 45.0

50.0

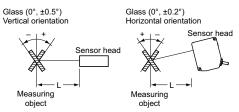
(Center)

Measuring distance L (mm in)

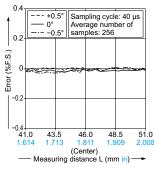
52.5

55.0

Setup mode: Specular reflection

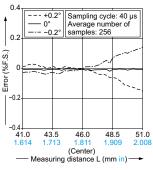


Vertical orientation



· Horizontal orientation

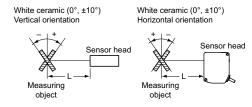
47.5



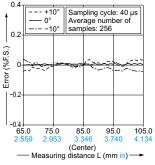
HL-C208B HL-C208C

Correlation between measuring distance and error characteristics

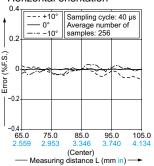
Setup mode: Diffuse reflection



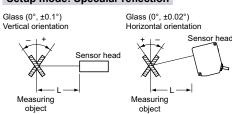
Vertical orientation



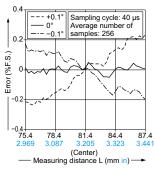
· Horizontal orientation



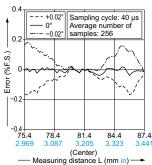
Setup mode: Specular reflection



Vertical orientation



· Horizontal orientation



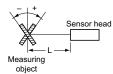
SENSING CHARACTERISTICS (TYPICAL)

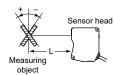
HL-C211B HL-C211C HL-C211F HL-C211F5

Correlation between measuring distance and error characteristics

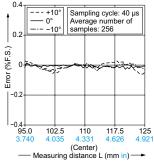
Setup mode: Diffuse reflection

White ceramic (0°, ±10°) Vertical orientation White ceramic (0°, ±10°) Horizontal orientation

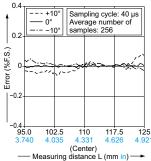




Vertical orientation



· Horizontal orientation

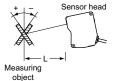


Setup mode: Specular reflection

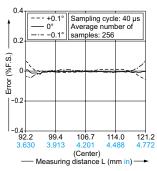
Aluminum vapor deposition surface reflection mirror (0°, ±0.1°) Vertical orientation



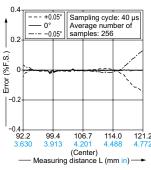
Aluminum vapor deposition surface reflection mirror (0°, ±0.05°) Horizontal orientation



Vertical orientation



Horizontal orientation



HL-C235BE HL-C235CE

Measuring

object

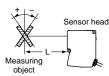
Correlation between measuring distance and error characteristics

Setup mode: Diffuse reflection

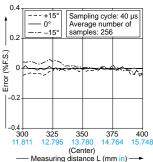
White ceramic (0°, ±15°) Vertical orientation

Sensor head Measuring

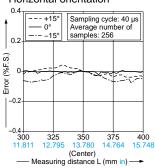
White ceramic (0°, ±15°) Horizontal orientation



Vertical orientation



Horizontal orientation



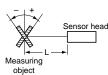
HL-C235CE-W

object

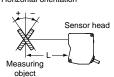
Correlation between measuring distance and error characteristics

Setup mode: Diffuse reflection

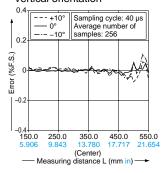
White ceramic (0°, ±10°) Vertical orientation



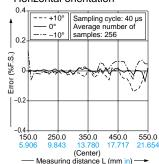
White ceramic (0°, ±10°)
Horizontal orientation



Vertical orientation



Horizontal orientation



PRECAUTIONS FOR PROPER USE

- This catalog is a guide to select a suitable product. Be sure to read instruction manual attached to the product prior to its use.
 - Never use this product as a sensing device for personnel protection.



- In case of using sensing devices for personnel protection, use products which meet laws and standards, such as OSHA, ANSI or IEC etc., for personnel protection applicable in each region or country.
- Do not use in environments with flammable gases. Usage may cause an explosion.

 Do not operate products using methods other than those described in the instruction manual included with each product. Control or adjustment through procedures other than those specified may cause hazardous laser radiation exposure.



- The following labels are attached to the products. Handle each product according to the instruction given on the warning label.
- Types which comply with FDA regulations have an English label applied based on those FDA regulations.

HL-C201A(E)(-MK) / HL-C201A(E)-SP2(M) / HL-C201A(E)-SP3(M)

 This product is classified as a Class 1 Laser Product in IEC / JIS standards. Do not look at the laser beam through optical devices such as a lens.



HL-C203B(E)(-MK) / HL-C205B(E)(-MK) / HL-C208B(E)(-MK) / HL-C211B(E)(-MK) / HL-C235BE(-MK)

 This product is classified as a Class 2 Laser Product in IEC / JIS standards. Do not look at the laser beam directly or through optical devices such as a lens.



HL-C205C(E)(-MK) / HL-C208C(E)(-MK) / HL-C211C(E)(-MK) / HL-C235CE(-MK) / HL-C235CE-W(-MK)

 This product is classified as a Class 3R Laser Product in IEC / JIS standards. Never directly look at or touch the laser beam or its reflection.



 Do not use outside of specification ranges for ratings, environmental conditions, etc.
 Abnormal heat or smoke generation may occur.



- Do not disassemble or modify these products. Electrical shock or smoke generation may occur.
- Connect electrical wires securely with terminal screws. Imperfect connections may cause abnormal heat or smoke generation.
- Do not touch the terminal while power is being supplied to the product. Electrical shock may occur.

 Exports of models with a minimum resolution of under 0.25 µm 0.010 mil fall under Japanese Export Control, which is defined by "Foreign Exchange and Foreign Trade Act"

Therefore, anyone who wishes to export or transfer these products outside of Japan is required to obtain the necessary license from the Ministry of Economy, Trade and Industry of Japan.

Also, these products fall under international export control regulations, such as Nuclear Suppliers Group (NSG) guidelines 1.B.3.b.1 and Wassenaar Arrangement (WA) 2.B.6.b.1.a, and are objects of the regulation. Please comply with the export control in each country.

Note: These products are introduced to limited countries only. Please contact our office for details.

Warming up time

 To ensure the performance of the product, before use allow at least 30 minutes of warming up after turning on the power.

Safety standards for laser beam products

 A laser beam can harm human being's eyes, skin, etc., because of its high energy density. IEC and JIS have classified laser products according to the degree of hazard and the stipulated safety requirements.

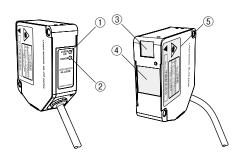
Safe use of laser products

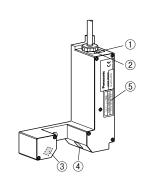
• For the purpose of preventing users from suffering injuries by laser products, IEC 60825-1(Safety of laser products). Please check the standards before use.

PRECAUTIONS FOR PROPER USE

Fuctional description

Sensor head

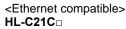


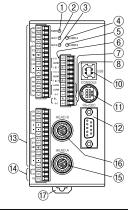


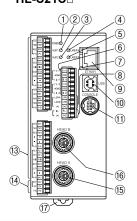
	Description	Function
1	Laser emission indicator (Green LED)	Lights up during laser emission.
2	Measurement range indicator (Yellow LED)	Lights up when the target reaches the approximate center of the measurement. Blinks when the target enters within the measurement range. Turns off the light when the target goes out of the measurement range.
3	Light emitter	Emits the laser light.
4	Light receiver	Receives the laser specular light from a measurement target.
(5)	Warning label	Shows the laser emission position. Please read carefully before use.

Controller

<RS-232C compatible>





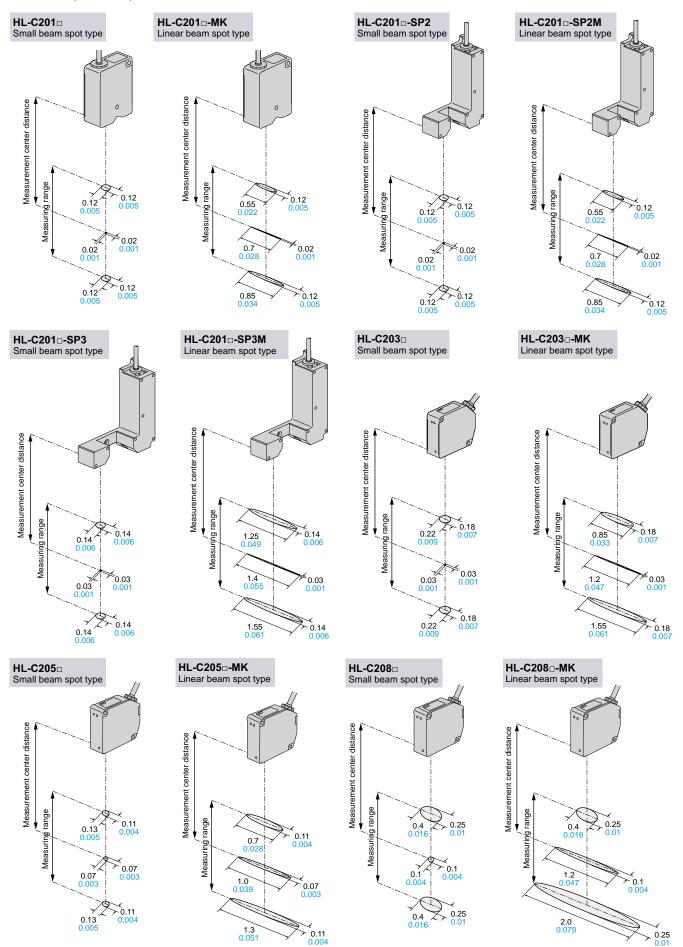


	Description	Function
1	POWER indicator	Lights up in green when electricity is provided to the controller.
2	ALM1 (Alarm) indicator	Abnormal condition indicator for OUT1. Lights up in red during dark status (poor light intensity) of OUT1 or the sensor head is in unconnected status.
3	ALM2 (Alarm) indicator	Abnormal condition indicator for OUT2. Lights up in red during dark status (poor light intensity) of OUT2 or the sensor head is in unconnected status.
4	LASER A indicator	Lights up in green during the laser radiation of Head A.
5	LASER B indicator	Lights up in green during the laser radiation of Head B.
6	Analog output terminal	Terminal for analog data output.
7	Laser control terminal	Stops laser emission in case of short-circuiting.
8	Remote interlock terminal	Stops laser emission when it's opened.
9	Ethernet connector	Equipped on HL-C21C models. Used for Ethernet communication with controllers.
10	USB connector	Used for communication with PC using USB.
11)	Console connection connector	Used for connecting the console.
12	RS-232C connector	Equipped on HL-C2C models. Used for RS-232C communication with controllers.
13	I/O terminal	Terminal for various I/O and memory change.
14)	Power terminal	Terminal for power supply to the controller.
(15)	Sensor head A connection connector	Controller recognizes a sensor head which is connected to this connector as "Sensor head A" and starts operation.
16	Sensor head B connection connector	Controller recognizes a sensor head which is connected to this connector as "Sensor head B" and starts operation.
7	DIN rail mounting hook	Used for hooking / removing the sensor heads to / from the 35 mm 1.378 in width DIN rail with one-touch simple operation.

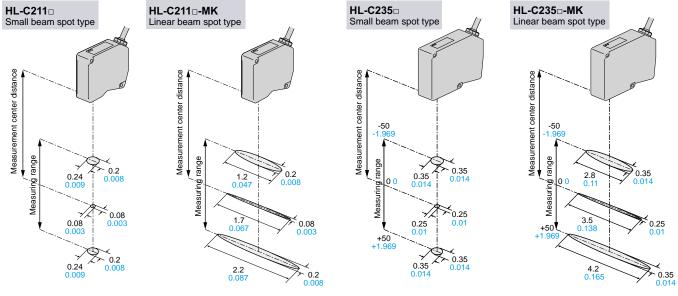
Note: In case of connecting one sensor head to the controller, be sure to connect the sensor head to (§) the sensor head A connection (HEAD A) side. If the sensor head is connected to (§) the sensor head B connection (HEAD B) side, the measurement cannot be performed.

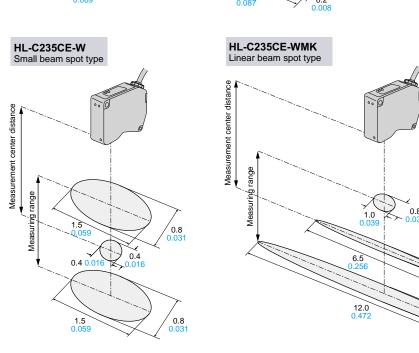
PRECAUTIONS FOR PROPER USE

Beam size (Unit: mm in)



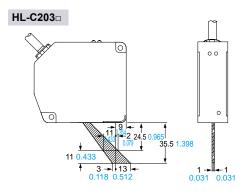
Beam size (Unit: mm in)

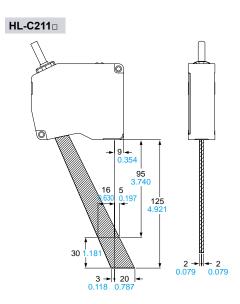


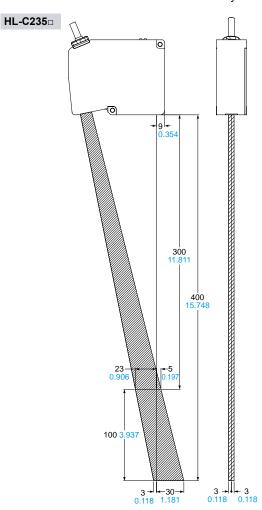


Mutual interference (Unit: mm in)

• When installing two or more sensor heads side by side, mutual interference will not occur if the laser spots from other sensor heads do not fall within the shaded areas in the figure below. When connecting two sensor heads to one controller, the mutual interference prevention function can be used. Therefore the measures shown below are not necessary in that case.

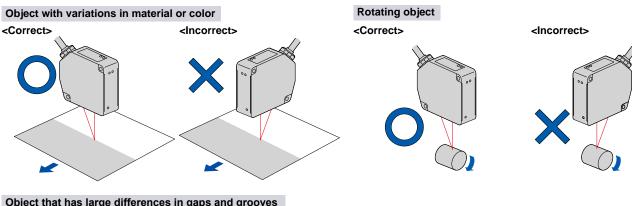


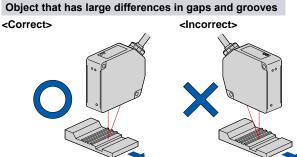




Sensor head mounting direction

• To obtain the greatest precision, the sensor head should be oriented facing the direction of movement of the object's surface, as shown in the figure below.



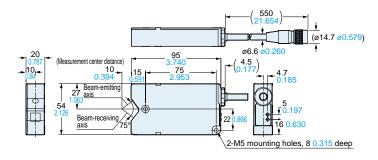


DIMENSIONS (Unit: mm in)

HL-C201 HL-C201 -- MK

Sensor head

Setup mode: Specular reflection type



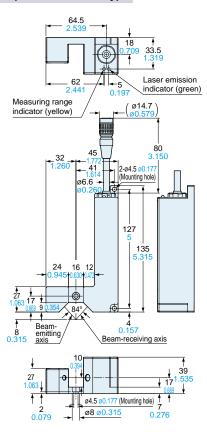
HL-C201 -- SP2 HL-C201 -- SP2M

Sensor head

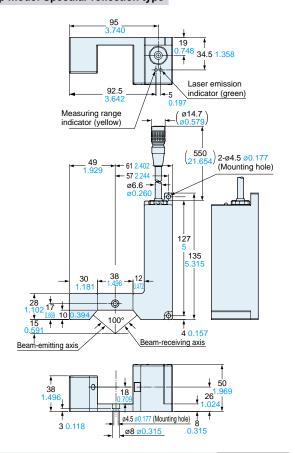
HL-C201 -SP3 HL-C201 -SP3M

Sensor head

Setup mode: Specular reflection type



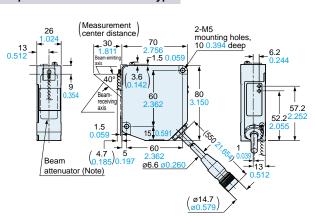
Setup mode: Specular reflection type



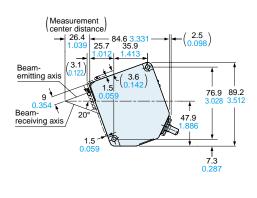
HL-C203□ HL-C203□-MK

Sensor head

Setup mode: Diffuse reflection type



Setup mode: Specular reflection type

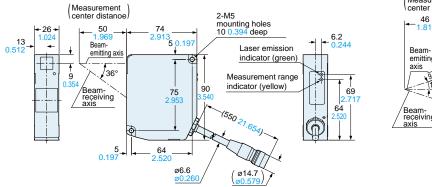


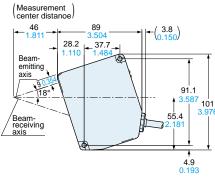
HL-C205□ HL-C205□-MK

Sensor head

Setup mode: Diffuse reflection type

Setup mode: Specular reflection type



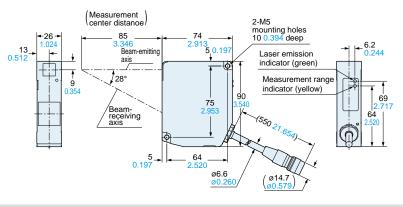


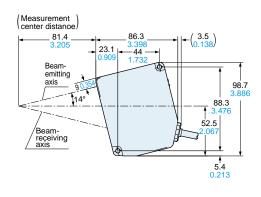
HL-C208□ HL-C208□-MK

Sensor head

Setup mode: Diffuse reflection type

Setup mode: Specular reflection type



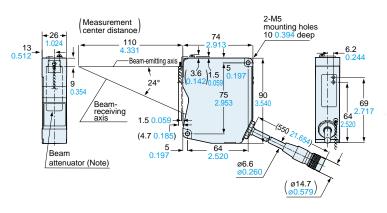


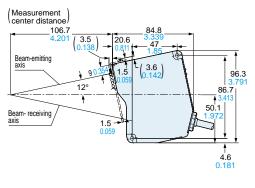
HL-C211 HL-C211 -- MK

Sensor head

Setup mode: Diffuse reflection type

Setup mode: Specular reflection type





Note: A beam attenuator is not available for JIS / IEC conformed types.

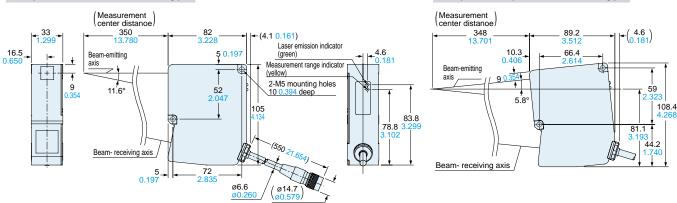
DIMENSIONS (Unit: mm in)

HL-C235 HL-C235 -MK

Sensor head

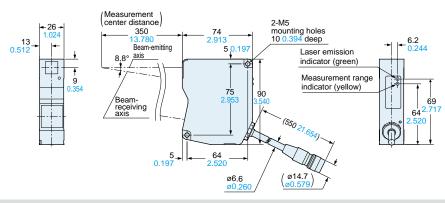
Setup mode: Diffuse reflection type

Setup mode: Specular reflection type



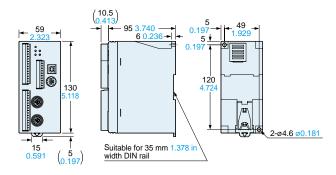
HL-C235CE-W HL-C235CE-WMK

Sensor head

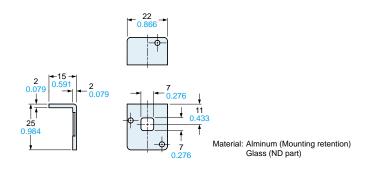


HL-C2C□ HL-C21C□

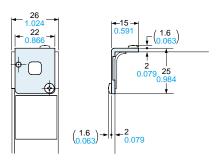
Controller



HL-C2F01 ND filter



Mounting drawing with a sensor head



Notes: 1) **HL-C201**□ cannot be mounted.

- For HL-C235□(-MK) models, mounting is on 2 places on the front panel.
- 3) Cannot be attached to FDA conformed types when a beam attenuator is in use.

Introduction to our Laser Displacement Sensors and Micro Laser Distance Sensors

Laser Displacement Sensor Compact (€ **HL-G1**SERIES

FDA

Micro Laser Distance Sensor CMOS type C FDA **HG-C**SERIES





Precision measurement with a resolution of 0.5 µm 0.02 mil (HL-G103). On-board controller for easy integration with other devices and production lines

A full range of models are available! We offer 10 diffuse reflection type models (Class 2) and 6 specular reflection type models (Class 1). These products excel in a variety of applications.



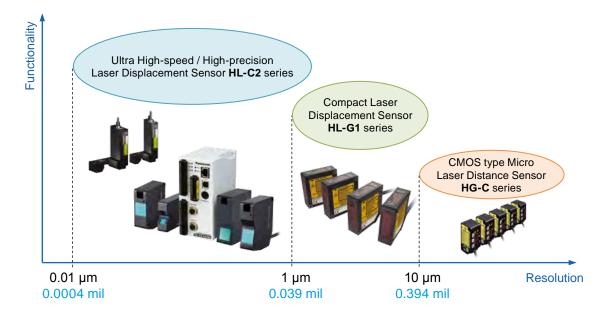
We have created CMOS laser sensor with a repeatable precision of 10 µm 0.394 mil for stable detection operation.

This product offers high-precision detection comparable to more expensive displacement sensors. It has an even smaller form-factor design, greater ease of installation, and a low price for competitive cost-performance. It can be used in equipment for working with circuit boards, in automobile assembly, and in various assembly and inspection processes



- Repeatable precision of 10 μm 0.394 mil (HG-C1030n)
- Compact size of W20 × H44 × D25 mm
- Uses an inflection resistant cable

Selection Guide



Disclaimer

The applications described in the catalog are all intended for examples only. The purchase of our products described in the catalog shall not be regarded as granting of a license to use our products in the described applications. We do NOT warrant that we have obtained some intellectual properties, such as patent rights, with respect to such applications, or that the described applications may not infringe any intellectual property rights, such as patent rights, of a third party

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